

BMI088

6-axis Motion Tracking for High-performance Applications



BMI088: Data Sheet

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Basic Description

BMI088 is an inertial measurement unit (IMU) for the detection of movements and rotations in 6 degrees of freedom (6DoF). It combines the functionality of two inertial sensors in one device: an advanced triaxial 16-bit gyroscope and a versatile, leading-edge triaxial 16-bit accelerometer.

BMI088 is designed to meet all requirements for high performance consumer applications in harsh vibration environments such as those encountered in drones and robotics applications. The IMU is designed to effectively suppress vibrations above a few hundred Hz that could occasionally occur due to resonances on the pcb or the structure of the total system.

The sensor has an extended measurement range of up to $\pm 24g$ to avoid signal clipping under strong signal exposure.

An evaluation circuitry (ASIC) converts the output of the micro-electro-mechanical sensing structures (MEMS), which are developed, produced and tested in BOSCH facilities. The corresponding chip-sets are packed into one single LGA 3.0mm x 4.5mm x 0.95mm housing. For optimum system integration, BMI088 is fitted with digital interfaces (SPI or I2C), offering a wide VDDIO voltage range from 1.2V to 3.6V. To provide maximum performance and reliability, each device is tested and is ready-to-use calibrated.

To increase flexibility, both gyroscope and accelerometer can not only be operated individually, but tied together for data synchronization purposes. The on-chip features comprise FIFOs for acceleration and gyroscope data and interrupt controllers.

The BMI088 has an excellent temperature behavior with an outstanding low temperature coefficient of the offset (TCO) and temperature coefficient of the sensitivity (TCS).

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1. Specification

If not stated otherwise, the given values are over lifetime and full performance temperature and voltage ranges, minimum/maximum values are $\pm 3\sigma$.

1.1 Electrical Specifications

Table 1: Electrical parameter specification

Parameter	Symbol	Condition	Min	Max	Unit
Supply Voltage Internal Domains	VDD		2.4	3.6	V
Supply Voltage I/O Domain	VDDIO		1.2	3.6	V
Voltage Input Low Level	V _{IL,a}	SPI & I ² C		0.3VDDIO	•
Voltage Input High Level	V _{IH,a}	SPI & I ² C	0.7VDDIO		-
Voltage Output Low Level	$V_{OL,a}$	I _{OL} <= 2mA, SPI		0.23VDDIO	•
Voltage Output High Level	V _{OH}	I _{OH} <= 2mA, SPI	0.8VDDIO		-
Operating Temperature	T _A		-40	+85	°C

1.1.1 Electrical Specifications: Accelerometer/Gyroscope

Table 2: Electrical parameter specification accelerometer

Parameter	Symbol	Condition	Min	Тур	Max	Units
Total Supply Current in Normal mode	I _{DD}	VDD = VDDIO =3.0V, 25°C, g _{FS4g}		150		μΑ
Total Supply Current in Suspend Mode	I _{DDsum}	VDD = VDDIO =3.0V, 25°C		3		μА
Power-up time	t _{s_up}	Time to first valid sample from suspend mode			1	ms

Table 3: Electrical parameter specification gyroscope

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Supply Current in Normal Mode	I _{DD}	VDD = VDDIO = 3.0V, 25°C, ODR =1kHz		5		mA
Supply Current in Suspend Mode	I _{DDsum}	VDD = VDDIO = 3.0V, 25°C		25		μΑ
Supply Current in Deep Suspend Mode	IDDdsum	VDD = VDDIO = 3.0V, 25°C		<5		μА
Start-up time	t _{su}	to ±1°/s of final value; from power-off		30		ms
Wake-up time	t _{wusm}	From suspend- and deep suspend-modes		30		ms
Wake-up time	twufpm	From fast power-up mode		10		ms

1.2 Accelerometer Specifications

Table 4: Accelerometer specifications

Parameter	Symbol	Condition	Min	Тур	Max	Units
Acceleration Range	g FS3g			±3		g
	g FS6g	Selectable		±6		g
	g FS12g	via serial digital interface		±12		g
	g FS24g			±24		g
Sensitivity	S _{3g}	g _{FS3g} , T _A =25°C		10920		LSB/g
	S _{6g}	g _{FS6g} , T _A =25°C		5460		LSB/g
	S _{12g}	g _{FS12g} , T _A =25°C		2730		LSB/g
	S _{24g}	g _{FS24g} , T _A =25°C		1365		LSB/g
Sensitivity Temperature Drift	TCS			0.002		%/K
Zero-g Offset	Off	Nominal VDD and VDDIO, 25°C, g _{FS6g}		20		mg
Zero-g Offset Temperature Drift	TCO			<0.2		mg/K
Output Data Rate	ODR		12.5		1600	Hz
Bandwidth range	BW	3dB cut-off frequency of the accelerometer depends on ODR and OSR	5		280 (245 for Z axis)	Hz
Nonlinearity	NL	best fit straight line, g _{FS3g}		0.5		%FS
Output Noise Density	N _{rms}	g _{FS3g} , T _A =25°C Nominal VDD supplies Normal mode		190 (Z-axis) 160 (X- & Y- axis)		μg/√Hz
Cross Axis Sensitivity	S	relative contribution between any two of the three axes		0.5		%
Alignment Error	EA	relative to package outline		0.5		0

1.3 Gyroscope Specifications

Table 5: Gyroscope specifications

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Range	R _{FS125}			125		°/s
	R _{FS250}	Selectable		250		°/s
	R _{FS500}	via serial digital interface		500		°/s
	R _{FS1000}			1000		°/s
	R _F S2000			2000		°/s
		Ta=25°C, R _{FS125}		262.144		LSB/º/s
		Ta=25°C, R _{FS250}		131.072		LSB/º/s
Sensitivity		Ta=25°C, R _{FS500}		65.536		LSB/º/s
		Ta=25°C, R _{FS1000}		32.768		LSB/º/s
		Ta=25°C, R _{FS2000}		16.384		LSB/º/s
Sensitivity tolerance		Ta=25°C, R _{FS2000}		±1		%
Sensitivity Change over Temperature	TCS	Nominal VDD supplies $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$ R_{FS2000}		±0.03		%/K
Sensitivity Supply Volt. Drift	Svdd	$T_A=25^{\circ}C$, $VDD_{min} \le VDD \le VDD_{max}$		<0.4		%/V
Nonlinearity	NL	best fit straight line R _{FS1000} , R _{FS2000}		±0.05		%FS
g-Sensitivity		Sensitivity to acceleration stimuli in all three axis (frequency <20kHz)			0.1	°/s/g
Zero-rate Offset	Off Ω_x Ω_y and Ω_z	Nominal VDD supplies T _x =25°C, slow and fast offset cancellation off		±1		°/s
Zero-rate Offset Change over Temperature	ТСО	Nominal VDD supplies $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$ R _{FS2000}		±0.015		°/s per K
Zero-rate Offset Supply Volt. Drift	$Off\Omega$ VDD	$T_A=25^{\circ}C$, $VDD_{min} \le VDD \le VDD_{max}$		<0.1		°/s /V
Output Noise	n rms	rms, BW=47Hz (@ 0.014°/s/√Hz)		0.1		°/s

Bandwidth BW	f _{-3dB}		523 230 116 64 47 32 23 12	Hz
Data rate (set of x,y,z rate)			2000 1000 400 200 100	Hz
Data rate tolerance (set of x,y,z rate)			±0.3	%
Cross Axis Sensitivity		Sensitivity to stimuli in non-sense-direction	±1	%

1.4 Temperature Sensor Specifications

Table 6: Temperature sensor specifications

Parameter	Symbol	Condition	Min	Тур	Max	Units
Temperature Sensor Measurement Range	Ts		-104		150	°C
Temperature Sensor Slope	dTs			0.125		K/LSB
Temperature Sensor Offset error	OTs	at 25°C		±1		K

1.5 Absolute Maximum Ratings

Table 7: Absolute maximum ratings

Parameter	Condition	Min	Max	Units
Voltage at Supply Pin	VDD Pin	-0.3	4	V
	VDDIO Pin	-0.3	4	V
Voltage at any Logic Pin	Non-Supply Pin	-0.3	VDDIO+0.3	V
Passive Storage Temp. Range	≤ 65% rel. H.	-50	+150	°C
	Duration ≤ 200µs		10,000	g
Mechanical Shock	Duration ≤ 1.0ms		2,000	g
	Free fall onto hard surfaces		1.8	m
ESD	HBM, at any Pin		2	kV
	CDM		500	V
	MM		200	V

Note: Stress above these limits may cause damage to the device. Exceeding the specified electrical limits may affect the device reliability or cause malfunction.

2. Block Diagram

Figure 1 shows the basic building blocks of the BMI088:

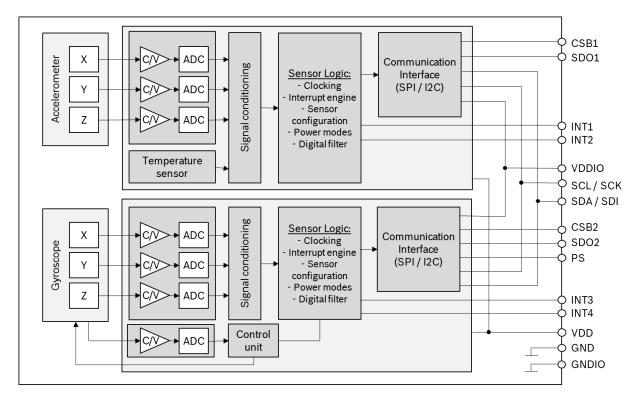


Figure 1: Block diagram of BMI088

3. Quick Start Guide - Device Initialization

For a proper device initialization, the following steps should be considered:

- The user must decide on the interface (I2C or SPI) already during HW design: with the PS pin the user determines which interface the sensor should listen to (see chapter 6).
- The gyroscope part of the BMI088 initializes its I/O pins according to the selection given by the PS pin.
- The accelerometer part starts in I2C mode. It will stay in I2C mode until it detects a rising edge on the CSB1 pin (chip select of the accelerometer), on which the accelerometer part switches to SPI mode and stays in this mode until the next power-up-reset.
- To change the accelerometer to SPI mode in the initialization phase, the user could perform a dummy SPI read operation, e.g. of register ACC_CHIP_ID (the obtained value will be invalid).

After the POR the gyroscope is in normal mode, while the accelerometer is in suspend mode. To switch the accelerometer into normal mode, the user must perform the following steps:

- a. Power up the sensor
- b. Wait 1 ms
- c. Enter normal mode by writing '4' to ACC_PWR_CTRL
- d. Wait for 450 microseconds

4. Functional Description

4.1 Power Management and Power Modes

The BMI088 has two distinct power supply pins:

- VDD is the main power supply for the internal blocks
- VDDIO is a separate power supply pin mainly used for the supply of the interface

There are no limitations on the voltage levels of both pins relative to each other, as long as each of them lies within its operating range. Furthermore, the device can be completely switched off (VDD = 0V) while keeping the VDDIO supply on (VDDIO > 0V) or vice versa.

When the VDDIO supply is switched off, all interface pins (CSB, SDI, SCK, PS) must be kept close to GND_{IO} potential.

The device contains a power-on reset (POR) generator. It resets the logic part and the register values after powering-on VDD and VDDIO. This means that all application specific settings which are not equal to the default settings (refer to 6.2 register map accelerometer and to 8.2 register map gyroscope), must be changed back to their designated values after POR.

Please note: the POR resets also the interface. For the gyroscope part, the interface is defined by the voltage level on the PS pin. The interface of the accelerometer part is defined by the voltage level of the CSB1 pin at the moment when the POR is initiated (see chapter 3).

4.1.1 Power Modes: Accelerometer

The power state of the BMI088 accelerometer is controlled through the register ACC_PWR_CTRL. The register ACC_PWR_CTRL enables and disables the accelerometer and the temperature sensor.

To enter **normal mode**, the value 0x04 must be written to ACC_PWR_CTRL.

To enter **suspend mode**, register ACC PWR CTRL must be cleared.

Note: The sensor is in suspend mode after reset (POR or soft-reset), thus the user actively needs to enter normal mode in order to obtain acceleration values.

Note: After POR or soft-reset, the acceleration sensor needs up to 1ms boot time (ts up)

4.1.2 Power Modes: Gyroscope

The gyroscope has 3 different power modes. Besides normal mode, which represents the fully operational state of the device, there are 2 energy saving modes: suspend mode and deep-suspend mode.

After power-up gyro is in normal mode so that all parts of the device are held powered-up and data acquisition is performed continuously.

In **suspend mode** the whole analog part is powered down. No data acquisition is performed. While in suspend mode the latest rate data and the content of all configuration registers are kept. The registers can still be read (though they are not updated).

Suspend mode is entered by writing 0x80 to the register GYRO_LPM1. It can be left by writing 0x00 to GYRO_LPM1 or by a soft reset (see 4.8).

Although write access to registers is supported at the full interface clock speed (SCL or SCK), a waiting period must be inserted between two consecutive write cycles (please refer also to section 9.2.1).

In **deep suspend mode** the device reaches the lowest possible power consumption. Only the interface section is kept alive. No data acquisition is performed and the content of the configuration registers is lost.

Deep suspend mode is entered by writing 0x20 to the register GYRO_LPM1. It can be left by writing 0x00 to GYRO LPM1 or by a soft reset (see 4.8).

Please note, that all application specific settings, which are not equal to the default settings, must be reset to its designated values after leaving deep-suspend mode.

Note: after POR or soft-reset, or when switching between the different power modes, the gyroscope sensor needs up to 30ms time to reach the new state. Any communication with the sensor during this time should be avoided.

4.2 Sensor Data

The width of the gyroscope and accelerometer sensor data is 16 bits (11 bits for the temperature sensor) given in two's complement representation.

The bits for each axis are split into an MSB upper part and an LSB lower part. Reading the sensor data registers shall always start with the LSB part. In order to ensure the integrity of the sensor data, the content of an MSB register is locked by reading the corresponding LSB register (shadowing procedure).

For details regarding the registers and the interpretation of the data found in these registers see:

- chapter 5.5.2 for the gyroscope part
- chapter 5.3.4 or the accelerometer part
- chapter 5.3.7 for the temperature sensor

The burst-access mechanism provides an efficient way to read out the angular rate data in I²C or SPI mode. During a burst-access, the sensor automatically increments the starting read address after each byte. The burst-access allows data to be transferred over the I²C bus with an up to 50% reduced data density. The sensor data (angular rate or acceleration data) in all read-out registers is locked as long as the burst read access is active. Reading the sensor data registers of each gyroscope and accelerometer part in burst read access mode ensures that the sensor values in all readout registers belong to the same sample.

4.3 Sensor Time

The accelerometer part of BMI088 has a built-in counter with a width of 24 bits. It increments periodically with a resolution of 39.0625µs. Details can be found in chapter 5.3.5.

4.4 Output Data Rate (ODR) and Low-pass Filter

The sensor signals from the acceleration sensor and gyroscope analog front-end are each routed through a low-pass filter.

4.4.1 Accelerometer

The 3db cut-off frequency of the digital low-pass filter depends on the chosen ODR as well as on the over-sampling-ratio (OSR). Both can be configured in register ACC_CONF. The following table lists the possible options:

Table 8: 3dB cutoff frequency of the accelerometer according to ODR and OSR settings in ACC_CONF register

Accelerometer ODR [Hz]	Normal (acc_bwp = 0xA)	OSR2 (acc_bwp = 0x9)	OSR4 (acc_bwp = 0x8)
12.5	5 Hz	2 Hz	1 Hz
25	10 Hz	5 Hz	3 Hz
50	20 Hz	9 Hz	5 Hz
100	40 Hz	19 Hz	10 Hz
200	80 Hz	38 Hz	20 Hz
400	145 Hz	75 Hz	40 Hz
800	230 Hz (200 Hz for z channel)	140 Hz	80 Hz
1600	280 Hz (245 Hz for z channel)	234 Hz (215 Hz for z channel)	145 Hz

4.4.2 Gyroscope

The user can choose between 8 different ODR and low pass filter bandwidth settings (see section 5.5.6).

4.5 Range Settings

The measurement range can be set through the registers described in section 5.3.11 for the accelerometer and in section 5.5.5 for the gyroscope.

4.6 Self-test

The BMI088 incorporates a self-test feature for both the accelerometer and the gyroscope, indicating whether the sensor is still ok.

4.6.1 Accelerometer

The self-test feature allows for checking the sensor functionality by applying electrostatic forces to the sensor core instead of external accelerations. By physically deflecting the seismic mass, the entire signal path of the sensor is tested. Activation of the self-test results in a static offset in the acceleration data. Any external acceleration or gravitational force, which is applied to the sensor during a self-test, will be observed in the sensor output as a superposition of the acceleration and the self-test signal. This means that the self-test signal depends on the orientation of the sensor. To overcome this, the full self-test procedure should be performed under static circumstances, e.g. when the part is not excited to any acceleration except gravity.

The recommended self-test procedure is as follows:

- 1) Set ±24g range by writing 0x03 to register ACC RANGE (0x41)
- 2) Set ODR=1.6kHz, continuous sampling mode, "normal mode" (norm_avg4) by writing 0xA7 to register ACC_CONF (0x40)
 - Continuous filter function: set bit7 in ACC_CONF
 - "normal avg4 mode": ACC CONF |= 0x02<<4
 - ODR=1.6kHz: ACC CONF |= 0x0C
- 3) Wait for > 2 ms
- 4) Enable the positive self-test polarity (i.e. write 0x0D to register ACC SELF TEST (0x6D))
- 5) Wait for > 50ms
- 6) Read the accelerometer offset values for each axis (positive self-test response)
- 7) Enable the negative self-test polarity (i.e. write 0x09 to register ACC SELF TEST (0x6D))
- 8) Wait for > 50ms
- 9) Read the accelerometer offset values for each axis (negative self-test response)
- 10) Disable the self-test (i.e. write 0x00 to register ACC_SELF_TEST (0x6D))
- 11) Calculate difference of positive and negative self-test response and compare with the expected values (see table below)
- 12) Wait for > 50ms to let the sensor settle to normal mode steady state operation

Table 9: Accelerometer self-test: resulting minimum difference signal between positive and negative self-test signal

x-axis signal	y-axis signal	z-axis signal
≥1000 mg	≥1000 mg	≥500 mg

It is recommended to perform a reset of the device after a self-test has been performed, since the self-test response also affects the interrupt generation. If the reset cannot be performed, the following sequence must be kept to prevent unwanted interrupt generation: disable interrupts, change parameters of interrupts, wait for at least 50ms, and enable desired interrupts.

4.6.2 Gyroscope

A built-in self-test facility of the gyro does not deflect the mechanical MEMS structure (as the accelerometer self-test does), but this test also provides a quick way to determine if the gyroscope is operational within the specified conditions.

To trigger the self-test, bit #0 ('bite_trig') in address GYRO_SELF_TEST must be set. When the test is finished, bit #1 ('bist_rdy') will be set by the gyro and the test result can then be found in bit #2 ('bist_fail'). A '0' indicates that the test was passed without issues. If a failure occurred, the bit 'bist_fail' will be set to '1'.

A further test which is running continuously in the background can be checked by reading bit #4 in address GYRO_SELF_TEST. Proper sensor function is indicated if the bit is set to '1'.

4.7 New Data Interrupt

Both accelerometer and gyroscope part offer a new data ready interrupt, which fires whenever a new data sample set is complete and made available in the corresponding sensor data registers. This allows a low latency data readout.

4.7.1 Accelerometer

The new data interrupt flag can be found in the register ACC_INT_STAT_1 (bit #7). It is set whenever new data is available in the data registers and cleared automatically.

The interrupt can be mapped to the interrupt pins INT1 and/or INT2 in register INT1_INT2_MAP_DATA.

Both interrupt pins INT1 and INT2 can be configured regarding their electrical behavior (see INT1 IO CONF and INT2_IO_CONF).

4.7.2 Gyroscope

The gyroscope provides a new data interrupt, which will generate an interrupt every time after storing a new value of z-axis angular rate data in the data register. The interrupt is cleared automatically after $280-400 \, \mu s$.

In contrast to the accelerometer part, for the gyro the new data interrupt must be explicitly enabled by writing 0x80 to the register GYRO_INT_CTRL.

The interrupt can be mapped to the interrupt pins INT3 and/or INT4 in register INT3_INT4_IO_MAP.

Both interrupt pins INT3 and INT4 can be configured regarding their electrical behavior (see INT3_INT4_IO_CONF).

4.8 Soft-Reset

A soft-reset can be initiated at any time

- for the accelerometer part by writing the command soft-reset (0xB6) to register ACC SOFTRESET (see 5.3.22)
- for the gyroscope part by writing the command *soft-reset* (0xB6) to register GYRO_SOFTRESET (see 5.5.8)

The soft-reset performs a fundamental reset to the device, which is largely equivalent to a power cycle. Following a delay, all user configuration settings are overwritten with their default state (setting stored in the NVM) wherever applicable. This command is functional in all operation modes but must not be performed while NVM writing operation is in progress.

4.8.1 Soft-Reset Accelerometer

Soft reset timing:

In I2C mode, the rising edge of the SCL line for the ACK bit of the soft reset transfer determines the reception of soft reset. The execution of the soft rest is delayed by 0.5 – 1us if the sensor is not in advanced power save mode i.e. PWR_CONF.adv_power_save=0b0.

The execution of the soft reset causes that the SDA line to be released immediately by the device, independent of the state of the SCL line.

If the host requires an explicit I2C ACK for the soft reset (i.e. SDA line remains low while the SCL line is high) the host must put the sensor in advance power save mode (PWR_CONF.adv_power_save=0b1), disable the sensor (PWR_CTRL.acc_en=0b0) and the auxillary interface (PWR_CTRL.aux_en=0b0) before issuing a soft reset.

4.9 FIFO

BMI088 offers two integrated FIFO (First In, First Out) buffers for accelerometer and gyroscope sensor signals, helping the user to reduce or even omit time critical read access to the sensor in order to obtain data with a high timing precision.

4.9.1 FIFO operating modes

The FIFO can be operated in different modes: FIFO (or stop-at-full) mode and STREAM mode.

- **FIFO or stop-at-full mode:** In FIFO or stop-at-full mode, the sensor values are stored in the FIFO buffer subsequently until it is full.
- STREAM mode: The STREAM mode works like the FIFO mode with the difference that once
 the buffer is full, the oldest data in the FIFO will be overwritten with the newest data from the
 sensor.

4.9.2 FIFO interrupts

The FIFO buffers support two different types of interrupts:

- Watermark interrupt: Triggered, when the fill level of the FIFO buffer reaches a user-defined level
- FIFO-full interrupt: Triggered, when the FIFO is full.

4.9.3 Accelerometer sensor FIFO buffer

The accelerometer part of BMI088 has an integrated 1024 byte data FIFO. The FIFO captures data from the data registers in frames, and each frame contains only one sample of a sensor.

4.9.3.1 Enabling FIFO and selecting the mode

The FIFO for accelerometer sensor data is enabled by setting bit #6 in register 0x49 (see 5.3.15).

4.9.3.1.1 Mode selection

When STREAM mode is desired, then the bit #0 in register 0x48 has to be cleared (set to '0') (default value on power up reset, see 5.3.14).

For FIFO or stop-at-full mode, bit #0 has to be set to '1' in register 0x48.

4.9.3.1.2 FIFO data sampling rate

The input data rate to the FIFO is the same as the configured ODR of the sensor. However, it can be reduced selecting a down-sampling factor of 2^k with k=[0, 1, ... 7]. The factor k must be written to bits #4-6 of register 0x45 (see 5.3.12).

4.9.3.1.3 FIFO synchronization with external interrupts (tag application) for the accel If the INT1 and/or INT2 pin is configured as input pin (by setting int2_io in register INT2_IO_CTRL and/or setting int1_io in register INT1_IO_CTRL), signals on these pins can also be recorded in the FIFO, and the frames are "tagged" accordingly. Therefore the pins need to be activated for FIFO recording in register FIFO_CONFIG_1 (see 5.3.15).

4.9.3.2 Data format in FIFO

The FIFO captures data in frames. The first byte is a header byte, defining the type of frame. From this, the number of consecutive bytes and their content can be derived.

The header byte consists of the header signature (first 6 bits) and two bits indicating the status of the interrupt pins INT1 and INT2 if configured accordingly (see 4.9.3.1.3).

4.9.3.2.1 Acceleration sensor data frame

- Frame length: 7 bytes (1 byte header + 6 bytes payload)
- Headers

Bit	7	6	5	4	3	2	1	0
	1	0	0	0	0	1	[INT2 tag]	[INT1 tag]

 Payload: the next bytes contain the sensor data in the same order as defined in the register map (addresses 0x12 - 0x17).

4.9.3.2.2 Skip Frame

In the case of FIFO overflows, in both FIFO and STREAM mode, a skip_frame is prepended to the FIFO content, when read out next time. A skip frame does not consume memory in the FIFO.

- Frame length: 2 bytes (1 byte header + 1 byte payload)
- Header:

Bit	7	6	5	4	3	2	1	0
	0	1	0	0	0	0	reserved	reserved

• Payload: one byte containing the number of skipped frames. When more than 0xFF frames have been skipped, 0xFF is returned.

4.9.3.2.3 Sensortime Frame

A sensortime frame is only sent if the FIFO becomes empty during the burst read. A sensortime frame does not consume memory in the FIFO.

- Frame length: 4 bytes (1 byte header + 3 bytes payload)
- Header:

Bit	7	6	5	4	3	2	1	0
	0	1	0	0	0	1	reserved	reserved

 Payload: Sensortime (content of registers 0x18 – 0x1A), taken when the last byte of the last frame is read.

4.9.3.2.4 FIFO input config Frame

Whenever the filter configuration or the range of the accelerometer sensor is changed, a FIFO input config frame is inserted into the FIFO, before the configuration change becomes active. E.g. when the bandwidth for the accelerometer filter is changed in Register ACC_CONF, a FIFO input config frame is inserted before the first frame with accelerometer data with the new bandwidth configuration.

- Frame length: 2 bytes (1 byte header + 1 byte payload)
- Header:

Bit	7	6	5	4	3	2	1	0
	0	1	0	0	1	0	reserved	reserved

- Payload: The FIFO input config frame contains one byte of data, of which the following bits have a meaning (the content of the other bits can safely be ignored):
 - Bit #1: indicates that a configuration change through register ACC_RANGE becomes active (means for example that the range of the accelerometer was changed).
 - Bit #0: indicates that a configuration change through the registers ACC_CONF or FIFO_DOWNS becomes active (means of example that the filter settings where changed or the FIFO sampling rate was modified).

4.9.3.2.5 Sample drop Frame

After a reconfiguration, indicated by the fifo_Input_Config frame, the next sample may be dropped, until the sensor delivers valid data again. Instead, a drop frame is inserted at the ODR tick at which a sample was to be expected without reconfiguration.

- Frame length: 2 bytes (1 byte header + 1 byte payload)
- Header:

Bit	7	6	5	4	3	2	1	0
	0	1	0	1	0	0	reserved	reserved

• Payload: The sample drop frame contains one byte of data, whose content can be ignored.

4.9.3.2.6 FIFO partial frame reads and overreads

When a frame is only partially (uncompletely) read through the register FIFO_DATA it will be repeated completely with the next access. In the case of a FIFO overflow between the first partial read and the second read attempt, the frame may be deleted.

When more data is read from the FIFO than it contains valid data, 0x8000 is returned.

4.9.3.3 FIFO Interrupts

The FIFO supports two interrupts, a FIFO full interrupt and a watermark interrupt:

- The FIFO full interrupt is issued when the FIFO fill level is above the full threshold. The full threshold is reached just before the last two frames are stored in the FIFO.
- The FIFO watermark is issued when the FIFO fill level is superior or equal to the watermark level defined in register FIFO_WTM (see 5.3.13).

In order to enable/use the FIFO full or watermark interrupts they need to be mapped on the desired interrupt pin via INT1_INT2_MAP_DATA (see 5.3.18).

Both interrupts are suppressed when a read operation on the register FIFO_DATA is ongoing. Latched FIFO interrupts will only get cleared, if the status register gets read and the fill level is below the corresponding FIFO interrupt (full or watermark).

4.9.3.4 FIFO Reset

The user can trigger a FIFO reset by writing 0xB0 to ACC SOFTRESET (register 0x7E).

4.9.4 Gyroscope sensor FIFO buffer

The gyroscope part of BMI088 features an integrated FIFO memory capable of storing up to 100 frames of data in FIFO mode. Each frame consists of three 16-bit rate_x,y,z data words, and 16 bits of interrupt data sampled at the same point in time.

4.9.4.1 Enabling FIFO and selecting the mode

The FIFO for gyroscope sensor data is enabled by setting the appropriate FIFO mode in Register 0x3E: FIFO_CONFIG_1.

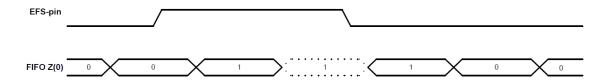
4.9.4.1.1 FIFO data sampling rate

The input data rate to the FIFO is the same as the configured ODR of the sensor.

4.9.4.1.2 FIFO sync with external interrupts (tag application) for the gyroscope

The FIFO of the gyroscope features a mode that allows the precise synchronization of external events with the gyroscope angular rate saved in the FIFO. This synchronization can be used for example for image and video stabilization applications.

Any of the gyroscope interrupt pins (INT3 or INT4) can be reconfigured to act as input pin, but not both. In addition, the tag mode has to be enabled. The so configured interrupt pin will then behave as an input pin and not as an interrupt pin. The working principle is shown in below figure:



Timing diagram for external FIFO synchronization. EFS-pin is the Interrupt pin configured to capture external events. FIFO z(0) is the least significant bit of the z-axis gyro data stored in the FIFO.

In order to enable the tag mode, bit 5 must be set in register 0x34 (see 5.5.13). The pin can be chosen in the same register, bit 4.

In this mode, the least significant bit of the z-axis is used as tag-bit, therefore losing its meaning as gyroscope data bit. The remaining 15 bits of the z-axis gyroscope data keep the same meaning as in standard mode.

Once the pin, which is configured for the tag mode, is set to high level, the next FIFO word will be marked with a tag (z-axis LSB = 1). While pin is kept at a high level, the corresponding FIFO words will continuously be tagged. After the pin is reset to low level, the immediate next FIFO word could still be tagged, and only after this word, the next tag will be reset (z-axis LSB=0). This is shown in the above diagram.

The tag synchronizes external events with the same time precision as the FIFO update rate. Therefore update rate of the tag is determined by the output data rate.

4.9.4.2 FIFO Data Readout

The FIFO stores the data that are also available at the read-out registers 0x02-0x07. Thus, all configuration settings apply to the FIFO data as well as the data readout registers. The FIFO read out is possible through register 0x3F (FIFO_DATA). The readout can be performed using burst mode. A single burst can read out one or more frames at a time. If a frame is not read completely due to an incomplete read operation, the remaining part of the frame is lost. In this case the FIFO aligns to the next frame during the next read operation.

The data format is described in 5.5.17.

4.9.4.2.1 Interface speed requirements for Gyroscope FIFO use

In order to use the FIFO effectively, larger blocks of data need to be read out quickly. Depending on the output data rate of the sensor, this can impose requirements on the interface.

The output data rate of the gyroscope is determined by the filter configuration (see the data sheet of the sensor). What interface speed is required depends on the selected rate.

- For an I²C speed of 400 kHz, every filter mode can be used.
- For an I²C speed of 200 kHz, only modes with an output data rate of 1 KHz and below are recommended.
- For an I²C speed of 100 kHz, only modes with an output data rate of 400 Hz and below are recommended.

4.9.4.3 FIFO Frame Counter and Overrun Flag

The frame counter (address 0x0E bits<6:0>, see 5.5.4) indicates the current fill level of the buffer. If additional frames are written to the buffer although the FIFO is full, the overrun flag (register 0x0E bit 7) is set. If the FIFO is reset, the FIFO fill level indicated in the frame_counter<6:0> is set to '0' and the overrun flag is reset each time a write operation happens to the FIFO configuration registers.

Note: the overrun bit is not reset when the FIFO fill level frame_counter<6:0> has decremented to '0' due to reading from the FIFO_DATA register, but only when a write operation is performed on FIFO configuration registers.

4.9.4.4 FIFO Interrupts

The FIFO supports two interrupts, a FIFO full interrupt and a watermark interrupt:

- The FIFO full interrupt is issued when the buffer has been fully filled with samples. In FIFO mode this occurs after 100 samples, and in STREAM mode after 99 samples, have been stored in a previously empty FIFO.
 The status of the FIFO-full interrupt may be read back through the status bit in INT STATUS_1 register 0x0A.
- The watermark interrupt is issued when the fill level in the buffer has reached the frame number defined by the water mark level trigger in 0x3D. The status of the watermark may be read back through the address 0x0A bit 4 (fifo_int) status bit. Writing to water mark level trigger in register 0x3D clears the FIFO buffer.

5. Register Maps

5.1 Communication with the sensor

The entire communication with the device is performed by reading from and writing to registers. Registers have a width of 8 bits; they are mapped to an 8-bit address space. Accelerometer and gyroscope have individual register maps. The selection of the appropriate register map is done on digital interface level by either selecting the corresponding chip select pin (SPI mode) or I²C address (I²C mode). For details regarding the digital interface, see chapter 0.

The functional registers and the register addresses containing functional bits are marked in the following register maps. All non-functional registers are marked as reserved and should be completely ignored by the user.

It is recommended to mask out (logical *and* with zero) non-functional bits (marked with '-') of registers which partially contain functional bits (i.e. read the register content first, changing bit by means of bitwise operations, and write the modified byte back to the register).

5.2 Register Map: Accelerometer

	Legend		Read	d-only	Read	/Write	Write	e-only	Rese	erved	
Addr	Name	Reset value	bit7	bit7 bit6 bit5 bit4			bit3	bit2	bit1	bit0	
0x7E	ACC SOFTRESET	0x00	softreset cmd (0xb6)								
0x7D	ACC_PWR_CTRL	0x00		acc enable							
0x7C	ACC_PWR_CONF	0x03				pwr_sav	e_mode				
	0x7B - 0x6E: reserved										
0x6D	ACC_SELF_TEST	0x00		acc_self_test							
	0x6B - 0x59: reserved						-				
0x58	INT_MAP_DATA	0x00	-	int2_drdy	int2_fwm	int2_ffull	-	int1_drdy	Int1_fwm	Int1_ffull	
	0x57 - 0x55: reserved						-				
0x54	INT2 IO CTRL	0x00		•		int2 in	int2 out	int2 od	int2 lvl	-	
0x53	INT1_IO_CTRL	0x00		-		int1_in	int1_out	int1_od	int1_lvl	-	
	0x52 - 0x4A: reserved										
0x49	FIFO_CONFIG_1	0x10	-	acc_en	-	1	int1_en	int2_en			
0x48	FIFO_CONFIG_0	0x02				-			1	mode	
0x47	FIFO_WTM_1	0x02		-			fifo_	_water_mark[1	12:8]		
0x46	FIFO_WTM_0	0x00	fifo_water_mark[7:0]								
0x45	FIFO_DOWNS	0x80	1 fifo_downs -								
	0x44 - 0x42: reserved										
0x41	ACC_RANGE	0x01				-				ange	
0x40	ACC_CONF	0xA8		acc_	bwp			acc	_odr		
	0x3F - 0x27: reserved						<u>- </u>				
0x26	FIFO_DATA	0x00				fifo_	data				
0x25	FIFO LENGTH 1	0x00		-		66 1 1		ounter[13:8]			
0x24	FIFO_LENGTH_0	0x00		t[0.0		tiro_byte_c	counter[7:0]				
0x23	TEMP_LSB	0x00	1	temperature[2:0	וי	tomporol	ture[10:3]	-			
0x22	TEMP MSB 0x21 - 0x1E: reserved	0x00					-				
0x1D	ACC INT STAT 1	0x00	ooo dedu				<u>. </u>				
OXID	0x1C - 0x1B: reserved		acc_drdy								
0x1A	SENSORTIME 2	0x00				sensor ti	me[23:16]				
0x19	SENSORTIME 1	0x00					time[15:8]				
0x18	SENSORTIME 0	0x00					time[7:0]				
0x17	ACC Z MSB	0x00									
0x16	ACC Z LSB	0x00	acc_z[15:8] acc_z[7:0]								
0x15	ACC Y MSB	0x00	acc_z[r.v]								
0x14	ACC Y LSB	0x00	acc_y[7:0]								
0x13	ACC_X_MSB	0x00	acc_(15:8]								
0x12	ACC_X_LSB	0x00	acc_x[7:0]								
	0x11 - 0x04: reserved		•								
0x03	ACC_STATUS	0x10	drdy_acc				-				
0x02	ACC_ERR_REG	0x00					error_code		-	fatal_err	
0x01	-	-					-				
0x00	ACC_CHIP_ID	0x1E				acc_c	hip_id				

5.3 Register Description: Accelerometer

5.3.1 Register 0x00: ACC_CHIP_ID

Bit	Access	Reset value	Description
[7:0]	RO	0x1E	Contains identifier code of acceleration sensor

5.3.2 Register 0x02: ACC_ERR_REG

Reports sensor error conditions.

Bit	Name	Access	Reset value	Description
[7:5]				reserved
[4:2]	error_code	RO	0x00	Error codes for persistent errors: 0x00: no error 0x01: error occurred in accelerometer configuration (unvalid data in register ACC_CONF)
[1]				reserved
[0]	fatal_err	RO	0x0	Fatal Error, chip is not in operational state (Boot-, power-system). This flag will be reset only by power-on-reset or soft-reset.

5.3.3 Register 0x03: ACC_STATUS

Sensor status flag.

Bit	Name	Access	Reset value	Description
[7]	acc_drdy	RO	0x0	Data ready for Accelerometer. Reset when one acceleration data register is read out.
[6:0]				reserved

5.3.4 Register 0x12 – 0x17: ACC data

Registers containing the acceleration sensor output. The sensor output is stored as signed 16 bit number in 2's complement format in each 2 registers. From the registers, the acceleration values can be calculated as follows:

```
Accel_X_int16 = ACC_X_MSB * 256 + ACC_X_LSB
Accel_Y_int16 = ACC_Y_MSB * 256 + ACC_Y_LSB
Accel_Z_int16 = ACC_Z_MSB * 256 + ACC_Z_LSB
```

When a register is read containing the LSB value of an acceleration value, the corresponding MSB register is locked internally, until it is read. By this mechanism, it is ensured that both LSB and MSB values belong to the same acceleration value and are not updated between the readouts of the individual registers.

The unit is in LSB. The conversion from LSB to acceleration (mg) is based on the range settings and can be calculated as follows (<0x41>: content of the ACC RANGE register):

```
 \begin{array}{l} Accel\_X\_in\_mg = Accel\_X\_int16 \,/\, 32768 * 1000 * 2^{(<0x41> + 1)} * 1.5 \\ Accel\_Y\_in\_mg = Accel\_Y\_int16 \,/\, 32768 * 1000 * 2^{(<0x41> + 1)} * 1.5 \\ Accel\_Z\_in\_mg = Accel\_Z\_int16 \,/\, 32768 * 1000 * 2^{(<0x41> + 1)} * 1.5 \\ \end{array}
```

5.3.5 Register 0x18 – 0x1A: Sensortime data

Registers containing the value of the internal 24-bit counter.

- Register 0x18 (SENSORTIME_0) contains the lower 8 bits of the counter. This register is incremented every 39.0625 μs.
- Register 0x19 (SENSORTIME_1) contains the middle 8 bits of the counter. This register is incremented on SENSORTIME_0 overflow, which is every 10 ms.
- Register 0x1A (SENSORTIME_2) contains the higher 8 bits of the counter. This register is incremented on SENSORTIME 1 overflow, which is every 2.56 s.

The complete 24-bit counter overflows after 655.36 s or almost 11 minutes.

5.3.6 Register 0x1D: ACC_INT_STAT_1

Interrupt status register.

Bit	Name	Access	Reset value	Description
[7]	acc_drdy	RO	0x00	Acceleration data ready interrupt. Cleared on read of this register
[6:0]				reserved

5.3.7 Register 0x22 – 0x23: Temperature sensor data

Registers containing the temperature sensor data output. The data is stored in an 11-bit value in 2's complement format. The resolution is 0.125°C/LSB, thus the temperature can be obtained as follows:

Temp_uint11 = (TEMP_MSB * 8) + (TEMP_LSB / 32) if Temp_uint11 > 1023:

 $Temp_int11 = Temp_uint11 - 2048$

else:

Temp int11 = Temp uint11

Temperature = Temp_int11 * 0,125°C/LSB + 23°C

TEMP_MSB	TEMP_LSB	Temp_int11	Temperature
0x3E	0x00	496	85 °C
0x00	0x60	3	23.375 °C
0x00	0x40	2	23.250 °C
0x00	0x20	1	23.125 °C
0x00	0x00	0	23.0°C
•••			
0xC1	0x00	-504	-40 °C
0x80			Invalid

The temperature sensor data is updated every 1.28 s.

5.3.8 Register 0x24-0x25: FIFO LENGTH

The FIFO length registers FIFO_LENGTH_1 and FIFO_LENGTH_0 contain the 14 bit FIFO byte counter. The counter represents the current fill level of the FIFO buffer.

An empty FIFO corresponds to 0x8000. A FIFO content reset can be triggered by reading out all frames from the FIFO buffer or by writing 0xB0 into register 0x7E. The byte counter is updated when a complete frame is read or written.

5.3.9 Register 0x26: FIFO DATA

When reading out data from FIFO, burst read access must be used. The address will not increase when burst read at the address of FIFO_DATA. The FIFO data is organized in frames as described in section 4.9.3.2.

When a frame is partially read through FIFO Data Register 0x26, it will be repeated completely with the next access. However, in case of a FIFO overflow between the first partial read and the second read attempt, the frame may be deleted.

5.3.10 Register 0x40: ACC_CONF

Accelerometer configuration register.

Bit	Name	Access	Reset value	Description	
[7:4]	acc_bwp RW		0x0A		onfluences the bandwidth of the w pass filter. For details, see assible values:
				acc_bwp	Filter setting
				0x08	OSR4 (4-fold oversampling)
				0x09	OSR2 (2-fold oversampling)
				0x0A	Normal
				others	reserved
[3:0]	[3:0] acc_odr RW	RW	0x08	This parameter s Possible values:	sets the output data rate ODR.
				acc_odr	ODR in Hz
				0x00 - 0x04	reserved
				0x05	12.5
				0x06	25
				0x07	50
				0x08	100
				0x09	200
				0x0A	400
				0x0B	800
				0x0C	1600
				0x0D - 0X0F	reserved

5.3.11 Register 0x41: ACC_RANGE

Accelerometer range setting register.

Bit	Name	Access	Reset value	Description	
[7:2]				reserved	
[1:0]	acc_range	RW	0x01	This parameter se Possible values:	ets the measurement range.
				acc_range	Range setting
				0x00	±3g
				0x01	±6g
				0x02	±12g
				0x03	±24g

5.3.12 Register 0x45: FIFO_DOWNS

Reduction of sample rate.

Bit	Name	Access	Reset value	Description
[7]	Reserved	RW	0x01	This bit must always be '1'.
[6:4]	fifo_downs	RO	0x00	Reduction of sample rate by a factor 2**fifo_downs. Example: fifo_downs=5 will reduce the FIFO sampling rate by a factor of 2**5 = 32 in relation to the chosen ODR of the sensor signal.
[3:0]				reserved

5.3.13 Register 0x46 - 0x47: FIFO_WTM

Registers containing the 13 bit FIFO watermark level value. A FIFO water mark interrupt signal is active if the FIFO fill level is equal or greater than fifo_water_mark [12:0] (unit of the fifo water mark is one byte).

5.3.14 Register 0x48: FIFO_CONFIG_0

Sets the FIFO mode.

Bit	Name	Access	Reset value	Description		
[7:2]				reserved		
[1]	Reserved	RW	0x01	This bit must alw	vays be '1'.	
[0]	mode	RW	0x00	This parameter sets the FIFO mode. Possible values:		
				value	mode	
				0x00	STREAM mode	
				0x01	FIFO mode	

5.3.15 Register 0x49: FIFO_CONFIG_1

Selects sources for the FIFO buffer.

Bit	Name	Access	Reset value	Description			
[7]	reserved						
[6]	Acc_en	RW	0x00	Enables storing of accelerometer sensor data			
[5]	Reserved	RW	0x00				
[4]	Reserved	RW	0x01	This bit must always be '1'.			
[3]	Int1_en	RW	0x00	Enables storing of captured interrupt events at pin INT1 (pin needs to be configured as input pin accordingly)			
[2]	Int2_en	RW	0x00	Enables storing of captured interrupt events at pin INT2 (pin needs to be configured as input pin accordingly)			
[1:0]				reserved			

5.3.16 Register 0x53: INT1_IO_CONF

Configures the input/output pin INT1.

Bit	Name	Access	Reset value	Description	
[7:5]				reserved	
[4]	int1_in	RW	0x00	Enable INT1 as in	put pin.
[3]	int1_out	RW	0x00	Enable INT1 as o	utput pin.
[2]	int1_od	RW	0x00	_	
				int1_od	Pin behavior
				0x00	Push-pull
				0x01	Open-drain
[1]	int1_lvl	RW	0x00		
			int1_lvl	Active state	
			0x00	Active low	
			0x01	Active high	
[0]				reserved	

5.3.17 Register 0x54: INT2_IO_CONF

Configures the input/output pin INT2.

Bit	Name	Access	Reset value	Description	
[7:5]				reserved	
[4]	int2_io	RW	0x00	Enable INT2 as in	put pin.
[3]	int2_out	RW	0x00	Enable INT2 as or	utput pin.
[2]	int2_od	RW	0x00		
				int2_od	Pin behavior
				0x00	Push-pull
				0x01	Open-drain
[1]	int2_lvl	RW	0x00		
				int2_lvl	Active state
				0x00	Active low
				0x01	Active high
[0]				reserved	

5.3.18 Register 0x58: INT1_INT2_MAP_DATA

Map data ready interrupt to output pin INT1 and/or INT2.

Bit	Name	Access	Reset value	Description
[7]				reserved
[6]	Int2_drdy	RW	0x00	Map data ready interrupt to pin INT2
[5]	int2_fwm	RW	0x00	Map FIFO watermark interrupt to pin INT2
[4]	int2_ffull	RW	0x00	Map FIFO full interrupt to pin INT2
[5:3]				reserved
[2]	Int1_drdy	RW	0x00	Map data ready interrupt to pin INT1
[1]	int1_fwm	RW	0x00	Map FIFO watermark interrupt to pin INT1
[0]	int1_ffull	RW	0x00	Map FIFO full interrupt to pin INT1

5.3.19 Register 0x6D: ACC_SELF_TEST

Enables the sensor self-test signal, occurring as a steady offset to the sensor output. Note that the self-test needs to be switched off actively by the user (details see 4.6.1).

Bit	Access	Reset value	Description				
[7:0]	RW	0x00					
			self_test	Behaviour			
						0x00	Self-test is switched off.
			0x0D Enable positive self-test		Enable positive self-test signal.		
			0x09	Enable negative self-test signal.			

5.3.20 Register 0x7C: ACC_PWR_CONF

Switches accelerometer into suspend mode for saving power. In this mode the data acquisition is stopped.

Bit	Name	Access	Reset value	Description	
[7:0]	acc_pwr_save	RW	0x03		
				acc_pwr_save	Filter setting
				0x03	Suspend mode
				0x00	Active mode

5.3.21 Register 0x7D: ACC_PWR_CTRL

Switches accelerometer ON or OFF. Required to do after every reset in order to obtain acceleration values.

Bit	Name	Access	Reset value	Description	
[7:0]	acc_enable	RW	0x00		
				acc_enable	Filter setting
				0x00	Accelerometer off
				0x04	Accelerometer on

5.3.22 Register 0x7E: ACC_SOFTRESET

Bit	Access	Reset value	Description
[7:0]	W	N/A	Writing a value of 0xB6 to this register resets the sensor. (Do not write any other content to this register.) Following a delay of 1 ms, all configuration settings are overwritten with their reset value. The soft-reset can be triggered from any operation mode.

5.4 Register Map: Gyroscope

	Legend	Read-only		Read/Write		Write-only		Reserved				
Addr	Name	Reset value	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0		
0x3F FIFO_DATA N/A			fifo_data_output_register									
0x3E	0x3E FIFO_CONFIG_1 0x00			fifo_mode -								
0x3D	FIFO_CONFIG_0	fifo_water_mark_level_trigger_retain										
0x3C	0x3C GYRO_SELF_TEST N/A		- rate_ok - bist_fail bist_rdy trig_bis							trig_bist		
0x3B - 0x35: reserved												
0x34	0x34 FIFO_EXT_INT_S		ext_fifo_s_en ext_fifo_s_sel -									
	0x33 - 0x1F: reserved											
0x1E	0x1E FIFO_WM_EN 0x00			fifo_watermark_enable								
	0x1D - 0x19: reserved											
0x18	0x18 INT3_INT4_IO_MAP		Int4_data	-	Int4_fifo	-		Int3_fifo	-	Int3_data		
	0x17: reserved											
0x16	0x16 INT3_INT4_IO_CONF		- Int4_od Int4_IV Int3_od Int3_IV									
0x15	GYRO_INT_CTRL 0x00		data_en fifo_en -									
0x14	0x14 GYRO_SOFTRESET N/A			softreset								
	0x13 - 0x12: reserved											
0x11	0x11 GYRO_LPM1 0x00			gyro_pm								
0x10	0x10 GYRO_BANDWIDTH 0x80			gyro_bw								
0x0F	GYRO_RANGE	gyro_range										
0x0E	0x0E FIFO_STATUS N/A		fifo_overrun fifo_frame_counter									
	0x0D - 0x0B: reserved			•								
0x0A	GYRO_INT_STAT_1	N/A	gyro_drdy		-	fifo_int			-			
	0x09 - 0x08: reserved											
0x07	0x07 RATE_Z_MSB N/A			rate_z[15:8]								
0x06	RATE_Z_LSB	rate_z[7:0]										
0x05	RATE_Y_MSB	rate_y[15:8]										
0x04	0x04 RATE_Y_LSB N/A			rate_y[7:0]								
0x03	:			rate_x[15:8]								
0x02	0x02 RATE_X_LSB N/A 0x01 Reserved N/A			rate_x[7:0]								
0x01	Reserved											
0x00	0x00 GYRO_CHIP_ID 0x0F			gyro_chip_id								

5.5 Register Description: Gyroscope

5.5.1 Register 0x00: GYRO CHIP ID

Bit	Access	Reset value	Description
[7:0]	RO	0x0F	Contains identifier code of gyroscope.

5.5.2 Register 0x02 – 0x07: Rate data

Registers containing the angular velocity sensor output. The sensor output is stored as signed 16-bit number in 2's complement format in each 2 registers. From the registers, the gyro values can be calculated as follows:

Rate_X: RATE_X_MSB * 256 + RATE_X_LSB Rate_Y: RATE_Y_MSB * 256 + RATE_Y_LSB Rate_Z: RATE_Z_MSB * 256 + RATE_Z_LSB

When a register is read containing the LSB value of a rate value, the corresponding MSB register is locked internally, until it is read. By this mechanism, it is ensured that both LSB and MSB values belong to the same rate range value and are not updated between the readouts of the individual registers.

The unit is in LSB. The conversion from LSB to angular velocity (degree per second) is based on the range settings (see 5.5.5). For example, for the default range setting of 0x00 in register 0x0F, the following conversion table applies:

Sensor output [LSB]	Angular rate (in 2000°/s range mode)
+32767	+ 2000°/s
•••	
0	0°/s
-32767	- 2000°/s

5.5.3 Register 0x0A: GYRO_INT_STAT_1

Bit	Name	Access	Reset value	Description
[7]	gyro_drdy	RO	N/A	Data ready interrupt status. The interrupt is cleared automatically after 280-400 µs.
[6:5]				reserved
[4]	fifo_int	RO	N/A	FIFO interrupt status
[3:0]				reserved

5.5.4 Register 0x0E: FIFO_STATUS

The register contains FIFO status information.

Bit	Name	Access	Reset value	Description
[7]	Fifo_overrun	RO	N/A	If set, FIFO overrun condition has occurred. Note: flag can only be cleared by writing to the FIFO configuration register FIFO_CONFIG_1
[6:0]	Fifo_frame_counter	RO	N/A	Current fill level of FIFO buffer. An empty FIFO corresponds to 0x00. The frame counter can be cleared by reading out all frames from the FIFO buffer or writing to the FIFO configuration register FIFO_CONFIG_1.

5.5.5 Register 0x0F: GYRO_RANGE

Bit	Access	Reset value	Description				
[7:0]	RW	0x00	Angular rate range	ate range and resolution. Possible values:			
			gyro_range	Full scale [°/s]	Resolution		
			0x00	±2000	16.384 LSB/°/s ⇔ 61.0 m°/s / LSB		
			0x01	±1000	32.768 LSB/°/s ⇔ 30.5 m°/s / LSB		
			0x02	±500	65.536 LSB/°/s ⇔ 15.3 m°/s / LSB		
			0x03	±250	131.072 LSB/°/s ⇔ 7.6 m°/s / LSB		
			0x04	±125	262.144 LSB/°/s ⇔ 3.8m°/s / LSB		

5.5.6 Register 0x10: GYRO_BANDWIDTH

Bit	Access	Reset value	Description			
[7:0]	RW	0x80 ¹	_	allows the selecti ate (ODR). Possi	ion of the rate data filter bandwidth and ible values:	
			gyro_bw	ODR [Hz]	Filter bandwidth [Hz]	
			0x00	2000	532	
			0x01	2000	230	
			0x02	1000	116	
			0x03	400	47	
			0x04	200	23	
			0x05	100	12	
			0x06	200	64	
			0x07	100	32	

¹ Note: bit #7 is read-only and always ,1', but has no function and can safely be ignored.

5.5.7 Register 0x11: GYRO_LPM1

Selection of the main power modes. Please note that only switching between normal mode and the suspend modes is allowed, it is not possible to switch between suspend and deep suspend and vice versa.

Bit	Access	Reset value	Description			
[7:0]	RW	0x00	Switch to the main	power modes.		
			gyro_pm	Power mode		
			0x00	normal		
			0x80	suspend		
			0x20	deep suspend		

5.5.8 Register 0x14: GYRO_SOFTRESET

Bit	Access	Reset value	Description
[7:0]	W	N/A	Writing a value of 0xB6 to this register resets the sensor. (Other values are ignored.)
			Following a delay of 30 ms, all configuration settings are overwritten with their reset value.
			The soft reset can be triggered from any operation mode.

5.5.9 Register 0x15: GYRO_INT_CTRL

Bit	Access	Reset value	Description
[7]	RW	0x0	Enables the new data interrupt to be triggered on new data.
[6]	RW	0x0	Enables the FIFO interrupt.
[5:0]			reserved

5.5.10 Register 0x16: INT3_INT4_IO_CONF

Sets electrical and logical properties of the interrupt pins.

Bit	Name	Access	Reset value	Description	
[3]	Int4_od	RW	'1'		
				Int4_od	Pin INT4 output configuration
				'0'	Push-pull
				'1'	Open-drain
[2]	Int4_lvl	RW	'1'		
				Int4_lvl	Pin INT4 active state
				'0'	Active low
				'1'	Active high
[1]	Int3_od	RW	'1'		_
				Int3_od	Pin INT3 output configuration
				'0'	Push-pull
				'1'	Open-drain
[0]	Int3_lvl	RW	'1'		
				Int3_lvl	Pin INT3 active state
				'0'	Active low
				'1'	Active high

5.5.11 Register 0x18: INT3_INT4_IO_MAP

Map the data ready interrupt pin to one of the interrupt pins INT3 and/or INT4.

Bit	Access	Reset value	Description
[7]	RW	0x0	Data ready interrupt is mapped to INT4 pin.
[6]			reserved
[5]	RW	0x0	FIFO interrupt is mapped to INT4.
[4:3]			reserved
[2]	RW	0x0	FIFO interrupt is mapped to INT3.
[1]			reserved
[0]	RW	0x0	Data ready interrupt is mapped to INT3 pin.

5.5.12 Register 0x1E: FIFO_WM_ENABLE

Enables FIFO watermark level interrupt.

Bit	Access	Reset value	Description	
[7:0]	RW	80x0		
			Value	description
			0x08	FIFO watermark level interrupt disabled
			0x88	FIFO watermark level interrupt enabled

5.5.13 Register 0x34: FIFO_EXT_INT_S

Bit	Access	Reset value	Description			
[7:6]	reserved					
[5]	RW	0x00	It set, enabl	It set, enables external FIFO synchronization mode		
[4]	RW	0x00	Selects source for external FIFO synchronization			
			ext_fifo Behavior _s_sel			
			0x0	Source is pin INT3		
			0x1 Source is pin INT4			
[3:0]		reserved				

5.5.14 Register 0x3C: GYRO_SELF_TEST

Built-in self-test of gyroscope.

Bit	Access	Name	Reset value	Description
[4]	R	rate_ok	'0'	A value of '1' indicates proper sensor function.
[2]	R	bist_fail	' 0'	If '0' and bist_rdy = '1': built-in self-test is ok, sensor is ok If '1' and bist_rdy = '1': built-in self-test is not ok, sensor values may not be in expected range
[1]	R	bist_rdy	'0'	If bit is '1', built-in self-test has been performed and finished
[0]	W	trig_bist	N/A	Setting this bit to '1' (i.e. writing 0x01 to this register) starts the built-in self-test.

5.5.15 Register 0x3D: FIFO_CONFIG_0

Bit	Access	Reset value	Description
[7]			Reserved
[6:0]	RW	0x00	fifo_water_mark_level_trigger_retain<6:0> defines the FIFO watermark level. An interrupt will be generated, when the number of entries in the FIFO exceeds fifo_water_mark_level_trigger_retain<6:0>. Writing to this register clears the FIFO buffer.

5.5.16 Register 0x3E: FIFO_CONFIG_1

Contains FIFO configuration settings. The FIFO buffer memory is cleared and the fifo-full flag is cleared when writing to FIFO_CONFIG_1 register. In addition, the FIFO overrun flag (see 5.5.4) is cleared (it overrun occurred before).

Bit	Access	Reset value	Description	on											
[7:0]	RW	0x08	fifo_												
			mode	mode	description										
			0x40	FIFO	data collection stops once buffer is full (i.e. filled with 100 frames)										
													0x80	STREAM	sampling continues when buffer is full (i.e. filled with 99 frames); old is discarded
			else		reserved										

5.5.17 Register 0x3F: FIFO DATA

FIFO data readout register. The format of the LSB and MSB components corresponds to that of the angular rate data readout registers. Read burst access may be used since the address counter will not increment when the read burst is started at the address of FIFO_DATA. The entire frame is discarded when a fame is only partially read out.

The format of the data read-out from register 0x3F is as follows:



Frame 1 (= 6 Bytes)

6. Digital Interface

The BMI088 supports two serial digital interface protocols for communication as a slave with a host device: SPI and I²C. The active interface is selected by the state of the Pin#07 (PS) 'protocol select' pin:

- PS = 'VDDIO' selects I2C
- PS = 'GND' selects SPI

Important:

- Please note that in case of SPI protocol the initialization process for the accelerometer part of BMI088 requires some additional steps (see chapter 3).
- Please also note that as the pins of the package are shared between accelerometer and gyroscope part, it is not advisable to configure different interfaces for the two parts.

Both digital interfaces share partly the same pins. Additionally each inertial sensor (accelerometer and gyroscope) provides specific interface pins, which allow the user to operate the inertial sensors independently of each other. The mapping for each interface and each inertial sensor is given in the following table:

Table 10: Mapping of the interface pins

Pin#	Name	use w/ SPI	use w/ I²C	Description
15	SDO1	SDO1	address	SPI: Accel Data Output I ² C: Used to set LSB of Accel I ² C address
10	SDO2	SDO2	address	SPI: Gyro Data Output I ² C: Used to set LSB of Gyro I ² C address
9	SDA/ SDI	SDI	SDA	SPI: Accel and Gyro Data In I ² C: Serial Data
14	CSB1	CSB1	unused	SPI: Accel Chip Select (enable)
5	CSB2	CSB2	unused	SPI: Gyro Chip Select (enable)
8	SCL/ SCK	SCK	SCL	SPI: Serial Clock SCK I ² C: Serial Clock SCL

The following table shows the electrical specifications of the interface pins:

Table 11: Electrical specification of the interface pins

Parameter	Symbol	Condition	Min	Тур	Max	Units
Pull-up Resistance, CSB pin	Rup	Internal Pull-up Resistance to VDDIO	75	100	125	kΩ
Input Capacitance	Cin			5	10	pF
I ² C Bus Load Capacitance (max. drive capability)	C _{12C_Load}				400	pF

In order to allow for the correct internal synchronisation of data written to the BMI088, a **wait time** of at least 2 µs (normal mode) or 1000 µs (suspend mode) must be followed.

6.1 Serial Peripheral Interface (SPI)

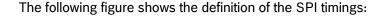
The behavior of the SPI interface is slightly different between gyroscope part and accelerometer part:

- Initialization phase: as described in chapter 3, the interface of the gyroscope part is selected by the level of the PS pin. In contrast to this, the accelerometer part starts always in I²C mode (regardless of the level of the PS pin) and needs to be changed to SPI mode actively by sending a rising edge on the CSB1 pin (chip select of the accelerometer), on which the accelerometer part switches to SPI mode and stays in this mode until the next power-up-reset. To change the sensor to SPI mode in the initialization phase, the user could perfom a dummy SPI read operation, e.g. of register ACC_CHIP_ID (the obtained value will be invalid).
- In case of read operations, the SPI interface of the accelerometer part does not send the requested information directly after the master has send the corresponding register address, but sends a dummy byte first, whose content is not predictable. Only after this dummy byte the desired content is sent. (This dummy byte procedure does not apply to the gyroscope part.) Please find more details below in section 6.1.2.

The timing specification for SPI of the BMI088 is given in the following table:

Table 12: SPI timing

Parameter	Symbol	Condition	Min	Max	Units
Clock Frequency	f _{SPI}	Max. Load on SDI or SDO = 25pF		10	MHz
SCK Low Pulse	t sckl		45		ns
SCK High Pulse	t sckH		45		ns
SDI Setup Time	tsDI_setup		20		ns
SDI Hold Time	tsDI_hold		20		ns
SDO Output Delay	t _{SDO_OD}	Load = 25pF		30	ns
		Load = 250pF, VDDIO > 2.4V		40	ns
CSB Setup Time	tcsB_setup		40		ns
CSB Hold Time	tcsB_hold		40		ns
Idle time between write accesses	tIDLE_wacc	normal mode	2		μs



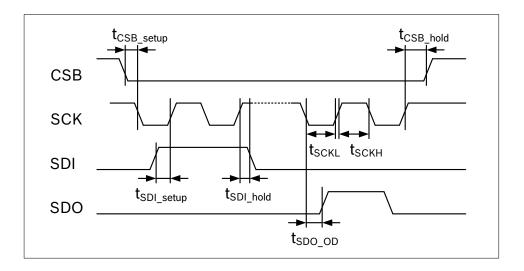


Figure 2: SPI timing diagram

The SPI interface of the BMI088 is compatible with two modes, '00' and '11'. The automatic selection between [CPOL = '0' and CPHA = '0'] and [CPOL = '1' and CPHA = '1'] is controlled based on the value of SCK after a falling edge of CSB (1 or 2).

6.1.1 SPI interface of gyroscope part

For single byte read as well as write operations, 16-bit protocols are used. The SPI interface also supports multiple-byte read operations (burst-read).

The communication starts when the CSB (1 or 2) is pulled low by the SPI master and stops when CSB (1 or 2) is pulled high. SCK is also controlled by SPI master. SDI and SDO (1 or 2) are driven at the falling edge of SCK and should be captured at the rising edge of SCK.

The data bits are used as follows:

- Bit #0: Read/Write bit. When 0, the data SDI is written into the chip. When 1, the data SDO from the chip is read.
- Bit #1-7: Address AD(6:0).
- Bit #8-15: when in write mode, these are the data SDI, which will be written into the address. When in read mode, these are the data SDO, which are read from the address.

Multiple read operations (**burst-read**) are possible by keeping CSB low and continuing the data transfer (i.e. continuing to toggle SCK). Only the first register address has to be written. Addresses are automatically incremented after each read access as long as CSB stays active low.

6.1.2 SPI interface of accelerometer part

In case of read operations of the accelerometer part, the requested data is not sent immediately, but instead first a dummy byte is sent, and after this dummy byte the actual reqested register content is transmitted.

This means that – in contrast to the description in section 6.1.1 – a single byte read operation requires to read 2 bytes in burst mode, of which the first received byte can be discarded, while the second byte contains the desired data.

The same applies to burst-read operations. For example, to read the accelerometer values in SPI mode, the user has to read 7 bytes, starting from address 0x12 (ACC data). From these bytes the user must discard the first byte and finds the acceleration information in byte #2 - #7 (corresponding to the content of the addresses 0x12 - 0x17).

The data bits are used as follows:

- Bit #0: Read/Write bit. When 0, the data SDI is written into the chip. When 1, the data SDO from the chip is read.
- Bit #1-7: Address AD(6:0).
- Bit #8-15:
 - When in write mode, these are the data SDI, which will be written into the address.
 - When in read mode, these bits contain unpredictable values, and the user has to read
 Bit #16-23 to get the actual data from the reading address.

6.2 Inter-Integrated Circuit (I2C)

The I²C bus uses SCL (= SCx pin, serial clock) and SDA (= SDx pin, serial data input and output) signal lines. Both lines are connected to VDDIO externally via pull-up resistors so that they are pulled high when the bus is free.

The I²C interface of the BMI088 is compatible with the I²C Specification UM10204 Rev. 03 (19 June 2007), available at http://www.nxp.com. The BMI088 supports I²C standard mode and fast mode, only 7-bit address mode is supported.

The **default I²C addresses** are:

- ▶ Accelerometer:
 - ► SDO1 pin pulled to 'GND': 0011000b (0x18)
 - ► SDO1 pin pulled to 'VDDIO': 0011001b (0x19)
- Gyroscope:
 - ▶ SDO2 pin pulled to 'GND': 1101000b (0x68)
 - ► SDO2 pin pulled to 'VDDIO': 1101001b (0x69)

The timing specification for I²C of the BMI088 is given in table 13:

Table 13: I²C timings

Parameter	Symbol	Min	Max	Units
Clock Frequency	f _{SCL}		400	kHz
SCL Low Period	tLow	1.3		μS
SCL High Period	tніGн	0.6		
SDA Setup Time	tsudat	0.1		
SDA Hold Time	thddat	0.0		
Setup Time for a repeated Start Condition	t susta	0.6		
Hold Time for a Start Condition	t hdsta	0.6		
Setup Time for a Stop Condition	t susto	0.6		
Time before a new Transmission can start	t BUF	1.3		
Idle time between write accesses, normal mode	t _{IDLE_wacc_nm}	2		μs
Idle time between write accesses, suspend mode	tIDLE_wacc_sum	450		μs

Figure 3 shows the definition of the I²C timings given in table 13:

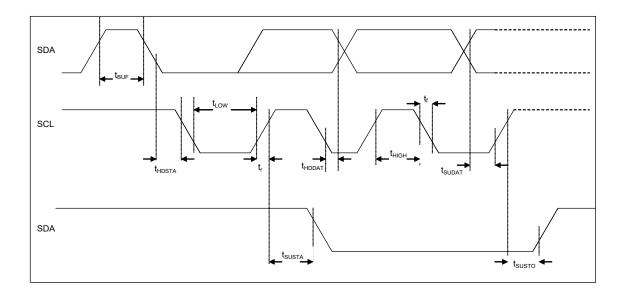


Figure 3: I²C timing diagram

The I²C protocol works as follows:

START: Data transmission on the bus begins with a high to low transition on the SDA line while SCL is held high (start condition (S) indicated by I²C bus master). Once the START signal is transferred by the master, the bus is considered busy.

STOP: Each data transfer should be terminated by a Stop signal (P) generated by master. The STOP condition is a low to HIGH transition on SDA line while SCL is held high.

ACK: Each byte of data transferred must be acknowledged. It is indicated by an acknowledge bit sent by the receiver. The transmitter must release the SDA line (no pull down) during the acknowledge pulse while the receiver must then pull the SDA line low so that it remains stable low during the high period of the acknowledge clock cycle.

In the following diagrams, these abbreviations are used:

S Start P Stop

ACKS Acknowledge by slave
ACKM Acknowledge by master
NACKM Not acknowledge by master

RW Read / Write

A START immediately followed by a STOP (without SCL toggling from 'VDDIO' to 'GND') is not supported. If such a combination occurs, the STOP is not recognized by the device.

I²C write access:

I²C write access can be used to write a data byte in one sequence.

The sequence begins with start condition generated by the master, followed by 7 bits slave address and a write bit (RW = 0). The slave sends an acknowledge bit (ACK = 0) and releases the bus. Then the master sends the one byte register address. The slave again acknowledges the transmission and waits for the 8 bits of data, which shall be written to the specified register address. After the slave acknowledges the data byte, the master generates a stop signal and terminates the writing protocol.

Example of an I²C write access to the accelerometer, writing 0xA8 to address ox40 (i.e. setting continuous filter function, averaging to 4 samples, ODR to 100Hz):

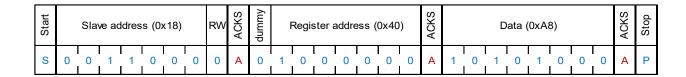


Figure 4: I2C write

I²C read access:

I²C read access also can be used to read one or multiple data bytes in one sequence.

A read sequence consists of a one-byte I²C write phase followed by the I²C read phase. The two parts of the transmission must be separated by a repeated start condition (Sr). The I²C write phase addresses the slave and sends the register address to be read. After slave acknowledges the transmission, the master generates again a start condition and sends the slave address together with a read bit (RW = 1). Then the master releases the bus and waits for the data bytes to be read out from slave. After each data byte the master has to generate an acknowledge bit (ACK = 0) to enable further data transfer. A

NACKM (ACK = 1) from the master stops the data being transferred from the slave. The slave releases the bus so that the master can generate a STOP condition and terminate the transmission.

The register address is automatically incremented and, therefore, more than one byte can be sequentially read out. Once a new data read transmission starts, the start address will be set to the register address specified in the latest I²C write command. By default, the start address is set at 0x00. In this way, repetitive multi-bytes reads from the same starting address are possible.

Example of an I^2C read access to the accelerometer, reading all 6 bytes containing acceleration data (0x12-0x17):

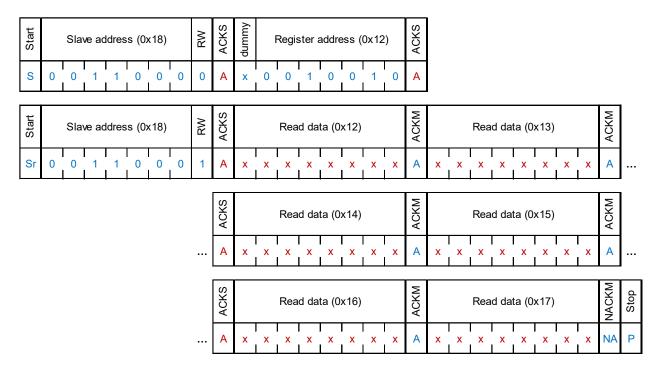
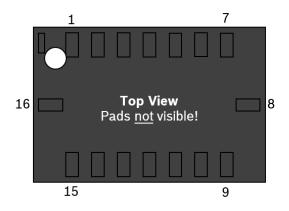


Figure 5: I2C multiple read

7. Pin-out and Connection Diagram



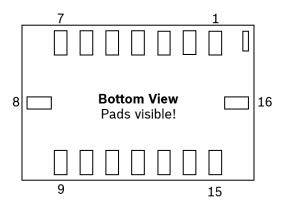


Figure 6: Pin-out top view

Figure 7: Pin-out bottom view

7.1 Pin-out

Table 14: Pin₁description

Pin#	Name	I/O Type	Description	SPI mode	I ² C mode
1*	INT2	Digital I/O	Interrupt pin 2 (accel int #2)	INT2	INT2
2	NC			GND	GND
3	VDD	Supply	Power supply analog & digital domain $(2.4 - 3.6V)$	VDD	VDD
4	GNDA	Ground	Ground for analog domain	GND	GND
5	CSB2	Digital in	SPI Chip select Gyro	CSB2	DNC (float)
6	GNDIO	Ground	Ground for I/O	GND	GND
7	PS	Digital in	Protocol select gyroscope (GND = SPI, VDDIO = I ² C)	GND	VDDIO
8	SCL/ SCK	Digital in	SPI: serial clock SCK I ² C: serial clock SCL	SCK	SCL
9	SDA/ SDI	Digital I/O	I ² C: SDA serial data I/O SPI 4W: SDI serial data I SPI 3W: SDA serial data I/O	SDI	SDA
10	SDO2	Digital out	SPI Serial data out Gyro Address select in I ² C mode see chapter 9.2	SDO2	GND for default addr.
11	VDDIO	Supply	Digital I/O supply voltage (1.2V 3.6V)	VDDIO	VDDIO
12*	INT3	Digital I/O	Interrupt pin 3 (gyro int #1)	INT3	INT3
13*	INT4	Digital I/O	Interrupt pin 4 (gyro int #2)	INT4	INT4
14	CSB1	Digital in	SPI Chip select Accel	CSB1	VDDIO or DNC (float)
15	SDO1	Digital out	SPI Serial data out Accel SDO1 Address select in I ² C mode see chapter 9.2		GND for default addr.
16*	INT1	Digital I/O	Interrupt pin 1 (accel int #1)	INT1	INT1

^{*} If INT are not used, do not connect them (DNC)!

7.2 Connection diagram SPI

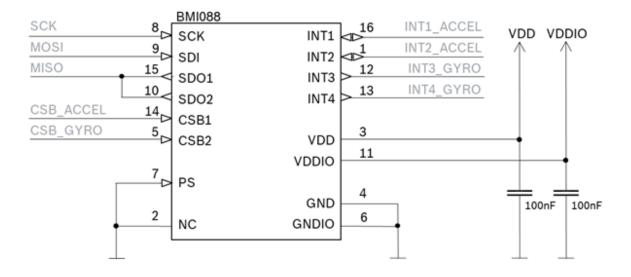


Figure 8: SPI connection

7.3 Connection diagram I²C

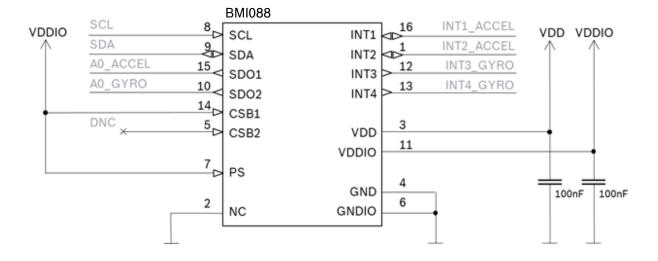
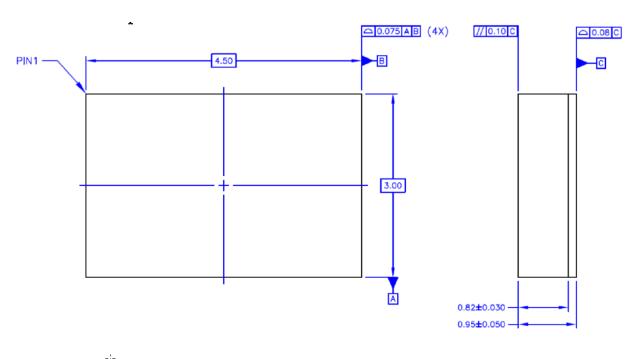


Figure 9: I²C connection

8. Package

8.1 Outline Dimensions

The sensor housing is a standard LGA package. Its dimensions are the following. Unit is mm. Note: Unless otherwise specified tolerance = decimal \pm 0.05



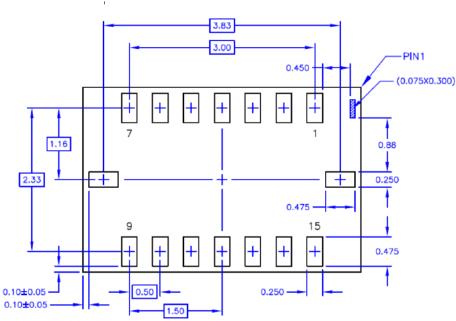


Figure 10: Package dimensions

8.2 Landing pattern

For the design of the landing patterns, we recommend the following dimensioning:

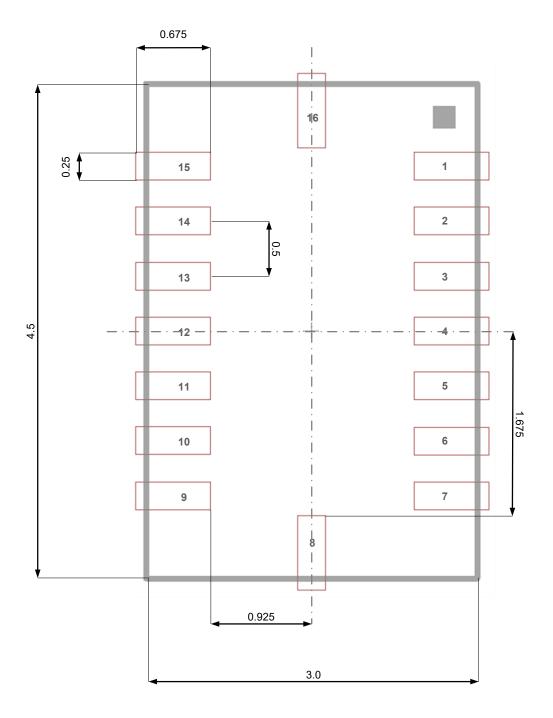


Figure 11: Landing pattern recommendation

Same tolerances as given for the outline dimensions in 8.1 should be assumed. A wiring no-go area in the top layer of the PCB below the sensor is strongly recommended (e.g. no vias, wires or other metal structures).

8.3 Sensing axes orientation

If the sensor is accelerated and/or rotated in the indicated directions, the corresponding channels of the device will deliver a positive acceleration and/or yaw rate signal (dynamic acceleration). If the sensor is at rest without any rotation and the force of gravity is acting contrary to the indicated directions, the output of the corresponding acceleration channel will be positive and the corresponding gyroscope channel will be "zero" (static acceleration).

Example: If the sensor is at rest or at uniform motion in a gravity field according to the figure given below, the output signals are:

•	0g for the X ACC channel	and	0° /sec for the Ω_X GYR channel
•	0g for the Y ACC channel	and	0° /sec for the Ω_{Y} GYR channel
•	+ 1g for the Z ACC channel	and	0° /sec for the Ω_Z GYR channel

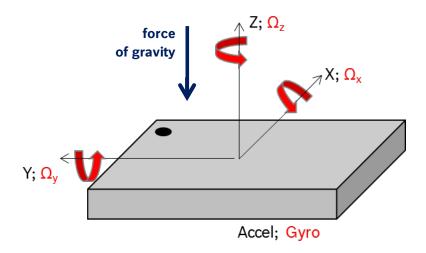


Figure 12: Orientation of sensing axis

The following table lists all corresponding output signals on X, Y, Z while the sensor is at rest or at uniform motion in a gravity field under assumption of a top down gravity vector as shown above. The gyroscope signals Ω_X , Ω_Y , Ω_Z show 0dps output under these static conditions.

Table 15: Output signals depending on device orientation

Sensor orientation (gravity vector ↓)	o	0	0	0	unricht	tdgirqu
Output Signal X	0g	+1g	0g	-1g	0g	0g
Output Signal Y	-1g	0g	+1g	0g	0g	0g
Output Signal Z	0g	0g	0g	0g	+1g	-1 <i>g</i>

8.4 Marking

8.4.1 Mass production samples

Table 16: Marking of mass production parts

Labeling	Name	Symbol	Remark
	Product number	365	3 numeric digits, fixed to identify product type
• 365	Sub-con ID	L	1 alphanumeric digit, variable to identify sub-con
LYYWW	Date-Code	YYWW	4 numeric digits, fixed to identify YY = "year" WW = "working week
	Lot counter	CCC	3 alphanumeric digits, variable to generate mass production trace-code
	Pin 1 identifier	•	-

8.4.2 Engineering samples

Table 17: Marking of engineering samples

Labeling	Name	Symbol	Remark
	Eng. sample ID	N	1 alphanumeric digit, fixed to identify engineering sample, N = "+" or "e" or "E"
• 088N PYYWW CC	Sample ID	PYYWW	P: assembly house YYWW: Year (last 2 digits)/Work week
	Counter ID	CC	C-samples; lot number (e.g.C5: C-samples, 5 th lot)
	Pin 1 identifier	•	

8.5 PCB layout and soldering guidelines

The following general layout rules are recommended

- PCB land width = LGA solder pin width
- PCB land length = LGA solder pin length + 0.1 mm on each side
- Solder mask opening width = PCB land width + 0.05 mm on each side
- Solder mask opening length = PCB land length + 0.05 mm on each side

Recommendation about stencil design and solder paste application

- It is recommended to keep the openings of the stencil mask for the signal pads between 70% and 90% of the PCB pad area.
- An accurate alignment of the stencil and the printed circuit board (within 0.025mm) is recommended.
- A stencil thickness of 80 150 μm is recommended for screen printing

The moisture sensitivity level (MSL) of the BMI088 sensors corresponds to JEDEC Level 1. See also:

- IPC/JEDEC J-STD-020E "Joint Industry Standard: Moisture/Reflow Sensitivity Classification for non-hermetic Solid State Surface Mount Devices"
- IPC/JEDEC J-STD-033D "Joint Industry Standard: Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices"

The sensor fulfils the lead-free soldering requirements of the above-mentioned IPC/JEDEC standard, i.e. reflow soldering with a peak temperature up to 260°C.

For more details, refer the Handling, Soldering and Mounting Instructions document available at https://www.bosch-sensortec.com/bst/support_tools/downloads/overview_downloads

8.6 Handling instructions

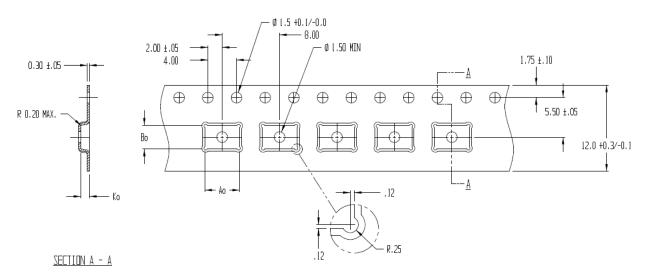
Micromechanical sensors are designed to sense acceleration with high accuracy even at low amplitudes and contain highly sensitive structures inside the sensor element. The MEMS sensor can tolerate mechanical shocks up to several thousand *g*'s. However, these limits might be exceeded in conditions with extreme shock loads such as e.g. hammer blow on or next to the sensor, dropping of the sensor onto hard surfaces etc.

We recommend to avoid *g*-forces beyond the specified limits during transport, handling and mounting of the sensors in a defined and qualified installation process.

This device has built-in protections against high electrostatic discharges or electric fields (e.g. 2kV HBM); however, anti-static precautions should be taken as for any other CMOS component. Unless otherwise specified, proper operation can only occur when all terminal voltages are kept within the supply voltage range. Unused inputs must always be tied to a defined logic voltage level.

8.7 Tape and Reel specification

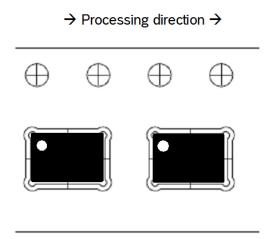
BMI088 is shipped in a standard cardboard box. The box dimension for each reel is $L \times W \times H = 35$ cm $\times 35$ cm $\times 5$ cm. Each reel contains 5,000pcs of BMI088.



 $A_0 = 4.85$; $B_0 = 3.35$; $K_0 = 1.20$

Tape and reel dimensions in mm

8.7.1 Orientation within the reel



Orientation of the BMI088 devices relative to the tape

8.8 Environmental safety

The BMI088 sensor meets the requirements of the EC restriction of hazardous substances (RoHS) directive, see also:

RoHS-Directive 2011/65/EU and its amendments, including the amendment 2015/863/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

8.8.1 Halogen content

The BMI088 is halogen-free. For more details on the analysis results please contact your Bosch Sensortec representative.

9. Legal Disclaimer

9.1 Engineering samples

Engineering Samples are marked with an asterisk (*), (E) or (e). Samples may vary from the valid technical specifications of the product series contained in this data sheet. They are therefore not intended or fit for resale to third parties or for use in end products. Their sole purpose is internal client testing. The testing of an engineering sample may in no way replace the testing of a product series. Bosch Sensortec assumes no liability for the use of engineering samples. The Purchaser shall indemnify Bosch Sensortec from all claims arising from the use of engineering samples.

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The purchaser accepts the responsibility to monitor the market for the purchased products, particularly with regard to product safety, and to inform Bosch Sensortec without delay of all safety-critical incidents.

9.3 Application examples and hints

With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Bosch Sensortec hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights or copyrights of any third party. The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. They are provided for illustrative purposes only and no evaluation regarding infringement of intellectual property rights or copyrights or regarding functionality, performance or error has been made.

10. Document History and Modification

Rev. No	Chapter	Description of modification/changes	Date	
1.0	-	Initial release	03-Dec-2017	
1.1	All	Typos	30-Jan-2018	
1.2	3 + 4.1.1 5.2 5.3.6 5.2+5.3.10+5.3.11 5.4	Updated switching between power modes Fixed typo in register range Added clearing condition of data ready int bit Corrected INT pin settings bits Fixed typo in bit naming in register 0x16	23-Mar-2018	
1.3	7.1	Updated pin 14 assignment in I2C mode	27-Apr-2018	
1.4	4.4.1 + 5.2 + 5.3.8 4.9 5.3.4 7.2 + 7.3 7.2 8.3 8.6	Clarified how to set Accel bandwidth setting Included info on FIFO Corrected conversion from LSB to mg Updated pin 4 and 6 assignment in SPI/I2C mode Clarified connection to SPI host interface Updated marking Included tape & reel specifications	16-Sep-2018	
1.5	4.9.1 - 4.9.4 5.2, 5.4 5.5.10 8.2 8.4.1 8.5, 8.8	Updated FIFO details Updated Register Maps with FIFO content Updated reset values of Gyro Reg 0x16 Included landing pattern Corrected lot counter typo Updated content Updated product use disclaimer	07-Feb-2020	
1.6	9	Disclaimer update	18-Nov-2020	
1.7	8.8 3 6.2	Environmental safety – RoHS directive update Device Initialization chapter update Timing t _{IDLE_wacc_sum} update	08-Nov-2021	
1.8	4.8	Soft Reset chapter updated 17-Jan-2022		



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